



## TPS709 150-mA, 30-V, 1- $\mu$ A $I_Q$ Voltage Regulators with Enable

### 1 Features

- Ultralow  $I_Q$ : 1  $\mu$ A
- Reverse Current Protection
- Low  $I_{SHUTDOWN}$ : 150 nA
- Input Voltage Range: 2.7 V to 30 V
- Supports 200-mA Peak Output
- 2% Accuracy Over Temperature
- Available in Fixed-Output Voltages: 1.2 V to 6.5 V
- Thermal Shutdown and Overcurrent Protection
- Packages: SOT-23-5, WSON-6

### 2 Applications

- Zigbee™ Networks
- Home Automation
- Metering
- Weighing Scales
- Portable Power Tools
- Remote Control Devices
- Wireless Handsets, Smart Phones, PDAs, WLAN, and Other PC Add-On Cards
- White Goods

### 3 Description

The TPS709 series of linear regulators are ultralow, quiescent current devices designed for power-sensitive applications. A precision band-gap and error amplifier provides 2% accuracy over temperature. Quiescent current of only 1  $\mu$ A makes these devices ideal solutions for battery-powered, always-on systems that require very little idle-state power dissipation. These devices have thermal-shutdown, current-limit, and reverse-current protections for added safety.

Shutdown mode is enabled by pulling the EN pin low. The shutdown current in this mode goes down to 150 nA, typical.

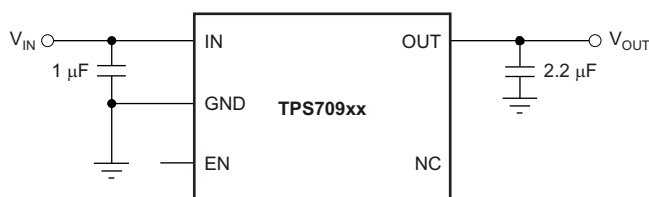
The TPS709 series is available in WSON-6 and SOT-23-5 packages.

#### Device Information<sup>(1)</sup>

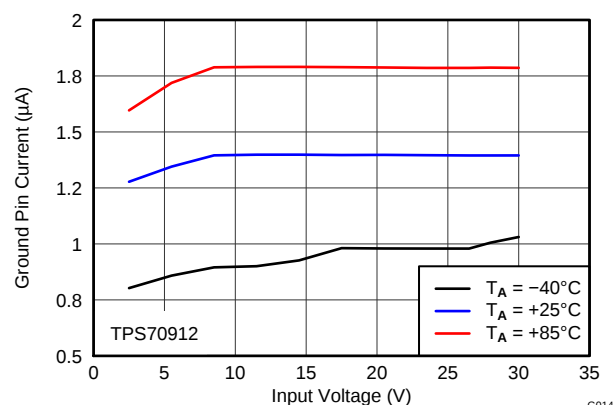
| PART NUMBER | PACKAGE    | BODY SIZE (NOM)   |
|-------------|------------|-------------------|
| TPS709      | SOT-23 (5) | 2.90 mm × 1.60 mm |
|             | WSON (6)   | 2.00 mm × 2.00 mm |

(1) For all available packages, see the package option addendum at the end of the datasheet.

Typical Application Circuit



GND Current vs  $V_{IN}$  and Temperature



G014



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## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

| Changes from Revision F (December 2014) to Revision G                                                                    | Page |
|--------------------------------------------------------------------------------------------------------------------------|------|
| • Added DBV package for TPS709A to <i>Pin Configurations and Functions</i> section                                       | 4    |
| • Added DBV package for TPS709B to <i>Pin Configurations and Functions</i> section                                       | 4    |
| • Added TPS709A and TPS709B to Pin Functions table                                                                       | 4    |
| • Moved operating junction temperature from <i>Electrical Characteristics</i> to <i>Recommended Operating Conditions</i> | 5    |

| Changes from Revision E (November 2013) to Revision F                                                                                                                                                                                                                                                                                  | Page |
|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Changed title format to meet latest data sheet standards                                                                                                                                                                                                                                                                             | 1    |
| • Added ESD Rating table, <i>Feature Description</i> section, <i>Device Functional Modes</i> , <i>Application and Implementation</i> section, <i>Power Supply Recommendations</i> section, <i>Layout</i> section, <i>Device and Documentation Support</i> section, and <i>Mechanical, Packaging, and Orderable Information</i> section | 1    |
| • Deleted SOT-223-4 package from document                                                                                                                                                                                                                                                                                              | 1    |
| • Deleted <i>Low Dropout</i> Features bullet                                                                                                                                                                                                                                                                                           | 1    |
| • Changed Packages Feature bullet: deleted SOT-223-4 and footnote                                                                                                                                                                                                                                                                      | 1    |
| • Deleted SOT-223-4 from last paragraph of <i>Description</i> section                                                                                                                                                                                                                                                                  | 1    |
| • Deleted pinout graphics from page 1                                                                                                                                                                                                                                                                                                  | 1    |
| • Deleted DCY package and footnote from Pin Configurations section                                                                                                                                                                                                                                                                     | 4    |
| • Changed Pin Functions table: changed title and deleted DCY package                                                                                                                                                                                                                                                                   | 4    |
| • Changed EN pin description in Pin Functions table                                                                                                                                                                                                                                                                                    | 4    |
| • Deleted the word 'range' from the last 2 rows of the Absolute Maximum Ratings table                                                                                                                                                                                                                                                  | 5    |
| • Deleted DCY column from Thermal Information table                                                                                                                                                                                                                                                                                    | 5    |
| • Added description text to the enabled mode discussion in the <i>Device Functional Modes</i> section                                                                                                                                                                                                                                  | 14   |

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**Changes from Revision D (October 2013) to Revision E**
**Page**


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|                                                                              |                   |
|------------------------------------------------------------------------------|-------------------|
| • Changed DRV (SON-6) package status from Preview to Production Data.....    | <a href="#">1</a> |
| • Deleted SON-6 package from footnote 1 in <i>Features</i> section.....      | <a href="#">1</a> |
| • Deleted DRV package from pinout diagram note.....                          | <a href="#">1</a> |
| • Deleted DRV from pinout note in the <i>Pin Configurations</i> section..... | <a href="#">4</a> |

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**Changes from Revision C (June 2013) to Revision D**
**Page**


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|                                                                              |                   |
|------------------------------------------------------------------------------|-------------------|
| • Changed device status from Production Data to Mixed Status.....            | <a href="#">1</a> |
| • Changed last Features bullet: added footnote and changed device order..... | <a href="#">1</a> |
| • Added note to pinout diagrams.....                                         | <a href="#">1</a> |
| • Added product preview footnote to pin configurations .....                 | <a href="#">4</a> |

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**Changes from Revision B (November 2012) to Revision C**
**Page**


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|                                                                                                                         |                   |
|-------------------------------------------------------------------------------------------------------------------------|-------------------|
| • Added DCY (SOT-223) and DRV (SON) packages to data sheet.....                                                         | <a href="#">1</a> |
| • Changed $I_Q$ feature bullet value from 1.35 $\mu$ A to 1 $\mu$ A.....                                                | <a href="#">1</a> |
| • Changed quiescent current value in first paragraph of <i>Description</i> section from 1.35 $\mu$ A to 1 $\mu$ A ..... | <a href="#">1</a> |
| • Changed text in second paragraph of <i>Description</i> section from "leakage" to "shutdown." .....                    | <a href="#">1</a> |
| • Added typical application circuit .....                                                                               | <a href="#">1</a> |
| • Added DCY and DRV packages to <i>Pin Configuration</i> section .....                                                  | <a href="#">4</a> |
| • Added DCY and DRV packages to Pin Descriptions table .....                                                            | <a href="#">4</a> |
| • Added DRV and DCY packages to Thermal Information table .....                                                         | <a href="#">5</a> |
| • Changed ground pin current typical values for $I_{OUT} = 0$ -mA test conditions.....                                  | <a href="#">6</a> |

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**Changes from Revision A (October 2012) to Revision B**
**Page**


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|                                                                                                                         |                    |
|-------------------------------------------------------------------------------------------------------------------------|--------------------|
| • Added <i>Pin Configuration</i> section .....                                                                          | <a href="#">4</a>  |
| • Changed <i>Line regulation</i> and <i>Load regulation</i> parameters in <i>Electrical Characteristics</i> table ..... | <a href="#">6</a>  |
| • Changed $I_{GND}$ parameter test conditions in <i>Electrical Characteristics</i> table .....                          | <a href="#">6</a>  |
| • Changed $I_{SHUTDOWN}$ parameter test conditions in <i>Electrical Characteristics</i> table .....                     | <a href="#">6</a>  |
| • Changed footnote 4 in <i>Electrical Characteristics</i> table .....                                                   | <a href="#">6</a>  |
| • Changed second paragraph of <i>Dropout Voltage</i> section .....                                                      | <a href="#">13</a> |

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**Changes from Original (March 2012) to Revision A**
**Page**

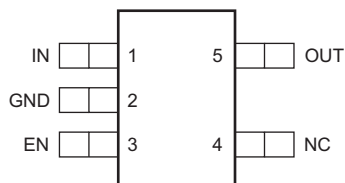

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|                                                                       |                   |
|-----------------------------------------------------------------------|-------------------|
| • Changed device status from Product Preview to Production Data ..... | <a href="#">1</a> |
|-----------------------------------------------------------------------|-------------------|

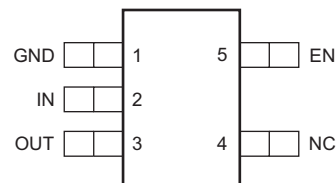
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## 5 Pin Configuration and Functions

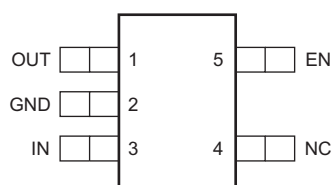
**TPS709: DBV Package  
5-Pin SOT-23  
Top View**



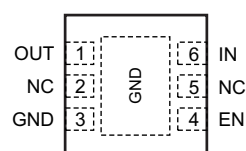
**TPS709B: DBV Package  
5-Pin SOT-23  
Top View**



**TPS709A: DBV Package  
5-Pin SOT-23  
Top View**



**DRV Package  
6-Pin WSON  
Top View**



### Pin Functions

| PIN         |        |        |         |         | I/O | DESCRIPTION                                                                                                                                                                                                            |
|-------------|--------|--------|---------|---------|-----|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME        | DRV    | DBV    |         |         |     |                                                                                                                                                                                                                        |
|             | TPS709 | TPS709 | TPS709A | TPS709B |     |                                                                                                                                                                                                                        |
| EN          | 4      | 3      | 5       | 5       | I   | Enable pin. Drive this pin high to enable the device. Drive this pin low to put the device into low current shutdown. This pin can be left floating to enable the device. The maximum voltage must remain below 6.5 V. |
| GND         | 3      | 2      | 2       | 1       | —   | Ground                                                                                                                                                                                                                 |
| IN          | 6      | 1      | 3       | 2       | I   | Unregulated input to the device                                                                                                                                                                                        |
| NC          | 2, 5   | 4      | 4       | 4       | —   | No internal connection                                                                                                                                                                                                 |
| OUT         | 1      | 5      | 1       | 3       | O   | Regulated output voltage. Connect a small 2.2-μF or greater ceramic capacitor from this pin to ground to assure stability.                                                                                             |
| Thermal pad |        | —      | —       | —       | —   | The thermal pad is electrically connected to the GND node. Connect this pad to the GND plane for improved thermal performance.                                                                                         |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

specified at  $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$  (unless otherwise noted); all voltages are with respect to GND<sup>(1)</sup>

|                                                |                   | MIN                                     | MAX | UNIT |
|------------------------------------------------|-------------------|-----------------------------------------|-----|------|
| Voltage                                        | V <sub>IN</sub>   | −0.3                                    | 32  | V    |
|                                                | V <sub>EN</sub>   | −0.3                                    | 7   |      |
|                                                | V <sub>OUT</sub>  | −0.3                                    | 7   |      |
| Maximum output current                         | I <sub>OUT</sub>  | Internally limited                      |     |      |
| Output short-circuit duration                  |                   | Indefinite                              |     |      |
| Continuous total power dissipation             | P <sub>DISS</sub> | See <a href="#">Thermal Information</a> |     |      |
| Operating junction temperature, T <sub>J</sub> |                   | −55                                     | 150 | °C   |
| Storage temperature, T <sub>stg</sub>          |                   | −55                                     | 150 | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|                                     |                                                                                | VALUE | UNIT |
|-------------------------------------|--------------------------------------------------------------------------------|-------|------|
| $V_{(ESD)}$ Electrostatic discharge | Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                                     | Charged device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±500  |      |

- (1) JEDEC document JEP155 states that 2-kV HBM allows safe manufacturing with a standard ESD control process.  
(2) JEDEC document JEP157 states that 500-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating junction temperature range (unless otherwise noted)

|           |                                | MIN | NOM | MAX | UNIT               |
|-----------|--------------------------------|-----|-----|-----|--------------------|
| $V_{IN}$  | Input voltage                  | 2.7 |     | 30  | V                  |
| $V_{OUT}$ | Output voltage                 | 1.2 |     | 6.5 | V                  |
| $V_{EN}$  | Enable voltage                 | 0   |     | 6.5 | V                  |
| $T_J$     | Operating junction temperature | -40 |     | 125 | $^{\circ}\text{C}$ |

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | TPS709 |        | UNIT                 |
|-------------------------------|----------------------------------------------|--------|--------|----------------------|
|                               |                                              | DBV    | DRV    |                      |
|                               |                                              | 5 PINS | 6 PINS |                      |
| $R_{\theta JA}$               | Junction-to-ambient thermal resistance       | 212.1  | 73.1   | $^{\circ}\text{C/W}$ |
| $R_{\theta JC(top)}$          | Junction-to-case (top) thermal resistance    | 78.5   | 97.0   | $^{\circ}\text{C/W}$ |
| $R_{\theta JB}$               | Junction-to-board thermal resistance         | 39.5   | 42.6   | $^{\circ}\text{C/W}$ |
| $\Psi_{JT}$                   | Junction-to-top characterization parameter   | 2.86   | 2.9    | $^{\circ}\text{C/W}$ |
| $\Psi_{JB}$                   | Junction-to-board characterization parameter | 38.7   | 42.9   | $^{\circ}\text{C/W}$ |
| $R_{\theta JC(bot)}$          | Junction-to-case (bottom) thermal resistance | N/A    | 12.8   | $^{\circ}\text{C/W}$ |

- (1) For more information about traditional and new thermal metrics, see the *IC Package Thermal Metrics* application report, [SPRA953](#).

## 6.5 Electrical Characteristics

At ambient temperature ( $T_A$ ) =  $-40^{\circ}\text{C}$  to  $+85^{\circ}\text{C}$ ,  $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$  or  $2.7\text{ V}$  (whichever is greater),  $I_{OUT} = 1\text{ mA}$ ,  $V_{EN} = 2\text{ V}$ , and  $C_{IN} = C_{OUT} = 2.2\text{-}\mu\text{F}$  ceramic, unless otherwise noted. Typical values are at  $T_A = 25^{\circ}\text{C}$ .

| PARAMETER        |                                         | TEST CONDITIONS                                                                                                                                | MIN | TYP | MAX  | UNIT                       |
|------------------|-----------------------------------------|------------------------------------------------------------------------------------------------------------------------------------------------|-----|-----|------|----------------------------|
| $V_{IN}$         | Input voltage range                     |                                                                                                                                                | 2.7 |     | 30   | V                          |
| $V_{OUT}$        | Output voltage range                    |                                                                                                                                                | 1.2 |     | 6.5  | V                          |
| $V_{OUT}$        | DC output accuracy                      | $V_{OUT} < 3.3\text{ V}$                                                                                                                       | -2% |     | 2%   |                            |
|                  |                                         | $V_{OUT} \geq 3.3\text{ V}$                                                                                                                    | -1% |     | 1%   |                            |
| $\Delta V_{OUT}$ | Line regulation                         | $(V_{OUT(\text{nom})} + 1\text{ V}, 2.7\text{ V}) \leq V_{IN} \leq 30\text{ V}$                                                                |     | 3   | 10   | mV                         |
|                  | Load regulation                         | $V_{IN} = V_{OUT(\text{typ})} + 1.5\text{ V}$ or $3\text{ V}$ (whichever is greater), $100\text{ }\mu\text{A} \leq I_{OUT} \leq 150\text{ mA}$ |     | 20  | 50   |                            |
| $V_{DO}$         | Dropout voltage <sup>(1)(2)</sup>       | TPS70933, $I_{OUT} = 50\text{ mA}$                                                                                                             |     | 295 | 650  | mV                         |
|                  |                                         | TPS70933, $I_{OUT} = 150\text{ mA}$                                                                                                            |     | 960 | 1400 |                            |
|                  |                                         | TPS70950, $I_{OUT} = 50\text{ mA}$                                                                                                             |     | 245 | 500  |                            |
|                  |                                         | TPS70950, $I_{OUT} = 150\text{ mA}$                                                                                                            |     | 690 | 1200 |                            |
|                  |                                         | TPS70965, $I_{OUT} = 50\text{ mA}$                                                                                                             |     | 180 | 500  |                            |
|                  |                                         | TPS70965, $I_{OUT} = 150\text{ mA}$                                                                                                            |     | 460 | 1000 |                            |
| $I_{(CL)}$       | Output current limit <sup>(3)</sup>     | $V_{OUT} = 0.9 \times V_{OUT(\text{nom})}$                                                                                                     | 200 | 320 | 500  | mA                         |
| $I_{GND}$        | Ground pin current                      | $I_{OUT} = 0\text{ mA}$ , $V_{OUT} \leq 3.3\text{ V}$                                                                                          |     | 1.3 | 2.05 | $\mu\text{A}$              |
|                  |                                         | $I_{OUT} = 0\text{ mA}$ , $V_{OUT} > 3.3\text{ V}$                                                                                             |     | 1.4 | 2.25 |                            |
|                  |                                         | $I_{OUT} = 150\text{ mA}$                                                                                                                      |     | 350 |      |                            |
| $I_{SHUTDOWN}$   | Shutdown current                        | $V_{EN} \leq 0.4\text{ V}$ , $V_{IN} = 2.7\text{ V}$                                                                                           |     | 150 |      | nA                         |
| PSRR             | Power-supply rejection ratio            | $f = 10\text{ Hz}$                                                                                                                             |     | 80  |      | dB                         |
|                  |                                         | $f = 100\text{ Hz}$                                                                                                                            |     | 62  |      |                            |
|                  |                                         | $f = 1\text{ kHz}$                                                                                                                             |     | 52  |      |                            |
| $V_n$            | Output noise voltage                    | $\text{BW} = 10\text{ Hz to } 100\text{ kHz}$ , $I_{OUT} = 10\text{ mA}$ , $V_{IN} = 2.7\text{ V}$ , $V_{OUT} = 1.2\text{ V}$                  |     | 190 |      | $\mu\text{V}_{\text{RMS}}$ |
| $t_{STR}$        | Start-up time <sup>(4)</sup>            | $V_{OUT(\text{nom})} \leq 3.3\text{ V}$                                                                                                        |     | 200 | 600  | $\mu\text{s}$              |
|                  |                                         | $V_{OUT(\text{nom})} > 3.3\text{ V}$                                                                                                           |     | 500 | 1500 |                            |
| $V_{EN(HI)}$     | Enable pin high (enabled)               |                                                                                                                                                | 0.9 |     |      | V                          |
|                  | Enable pin high (disabled)              |                                                                                                                                                | 0   |     | 0.4  |                            |
| $I_{EN}$         | EN pin current                          | $EN = 1.0\text{ V}$ , $V_{IN} = 5.5\text{ V}$                                                                                                  |     | 300 |      | nA                         |
| $I_{(REV)}$      | Reverse current (flowing out of IN pin) | $V_{OUT} = 3\text{ V}$ , $V_{IN} = V_{EN} = 0\text{ V}$                                                                                        |     | 10  |      | nA                         |
|                  | Reverse current (flowing into OUT pin)  | $V_{OUT} = 3\text{ V}$ , $V_{IN} = V_{EN} = 0\text{ V}$                                                                                        |     | 100 |      |                            |
| $t_{SD}$         | Thermal shutdown temperature            | Shutdown, temperature increasing                                                                                                               |     | 158 |      | $^{\circ}\text{C}$         |
|                  |                                         | Reset, temperature decreasing                                                                                                                  |     | 140 |      |                            |

(1)  $V_{DO}$  is measured with  $V_{IN} = 0.98 \times V_{OUT(\text{nom})}$ .

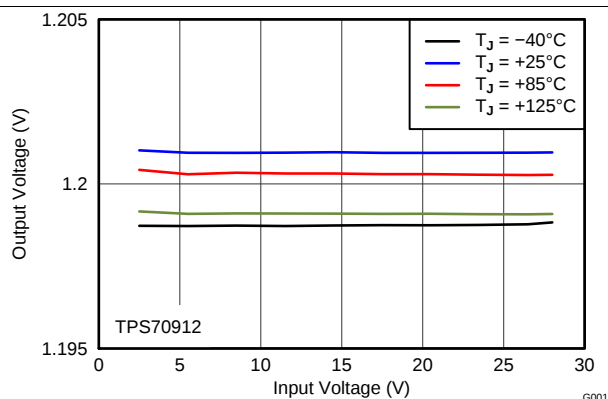
(2) Dropout is only valid when  $V_{OUT} \geq 2.8\text{ V}$  because of the minimum input voltage limits.

(3) Measured with  $V_{IN} = V_{OUT} + 3\text{ V}$  for  $V_{OUT} \leq 2.5\text{ V}$ . Measured with  $V_{IN} = V_{OUT} + 2.5\text{ V}$  for  $V_{OUT} > 2.5\text{ V}$ .

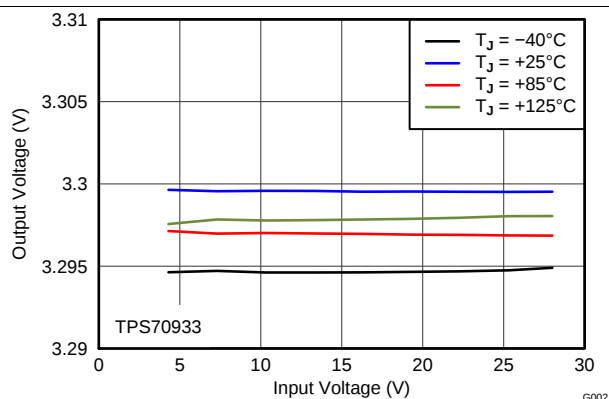
(4) Startup time = time from EN assertion to  $0.95 \times V_{OUT(\text{nom})}$  and load =  $47\text{ }\Omega$ .

## 6.6 Typical Characteristics

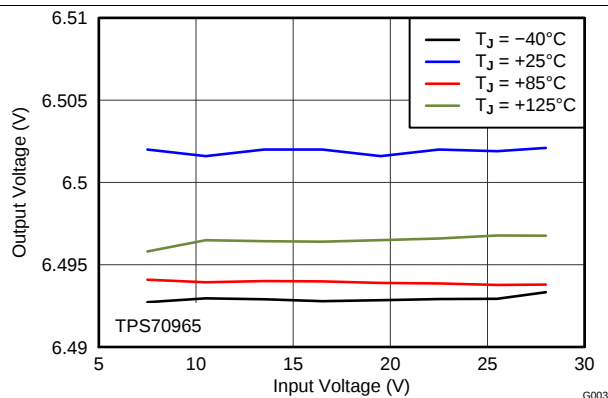
Over operating temperature range ( $T_J = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ),  $I_{\text{OUT}} = 10\text{ mA}$ ,  $V_{\text{EN}} = 2\text{ V}$ ,  $C_{\text{OUT}} = 2.2\text{ }\mu\text{F}$ , and  $V_{\text{IN}} = V_{\text{OUT(typ)}} + 1\text{ V}$  or  $2.7\text{ V}$  (whichever is greater), unless otherwise noted. Typical values are at  $T_J = 25^\circ\text{C}$ .



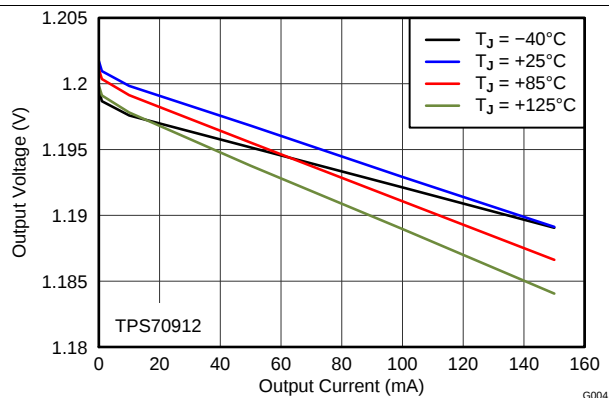
**Figure 1. 1.2-V Line Regulation vs  $V_{\text{IN}}$  and Temperature**



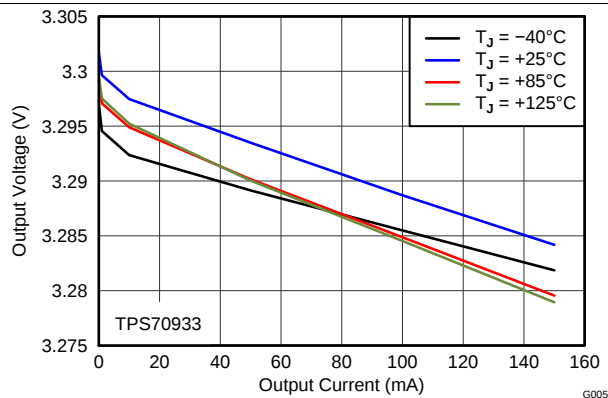
**Figure 2. 3.3-V Line Regulation vs  $V_{\text{IN}}$  and Temperature**



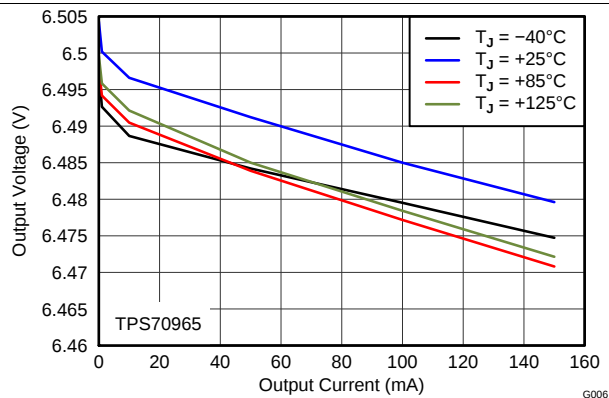
**Figure 3. 6.5-V Line Regulation vs  $V_{\text{IN}}$  and Temperature**



**Figure 4. 1.2-V Load Regulation vs  $I_{\text{OUT}}$  and Temperature**



**Figure 5. 3.3-V Load Regulation vs  $I_{\text{OUT}}$  and Temperature**



**Figure 6. 6.5-V Load Regulation vs  $I_{\text{OUT}}$  and Temperature**

## Typical Characteristics (continued)

Over operating temperature range ( $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ),  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = 2\text{ V}$ ,  $C_{OUT} = 2.2\text{ }\mu\text{F}$ , and  $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$  or  $2.7\text{ V}$  (whichever is greater), unless otherwise noted. Typical values are at  $T_J = 25^{\circ}\text{C}$ .

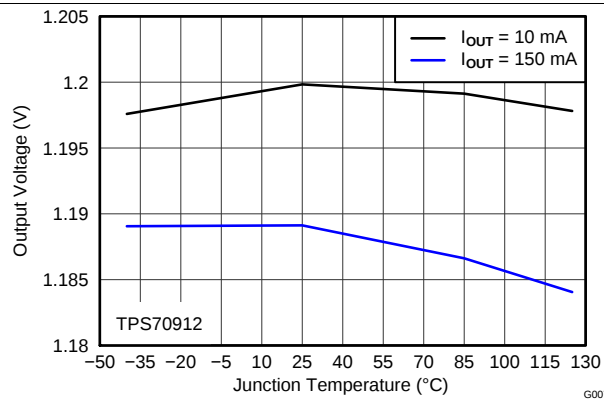


Figure 7.  $V_{OUT}$  vs Temperature

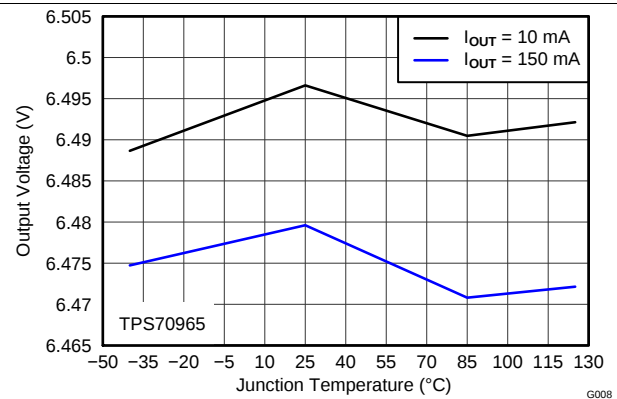


Figure 8.  $V_{OUT}$  vs Temperature

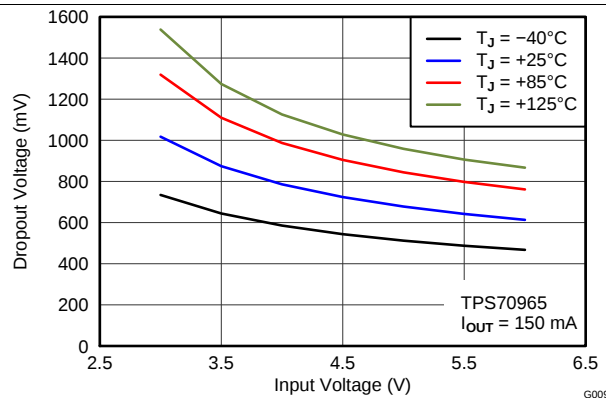


Figure 9. Dropout Voltage vs  $V_{IN}$  and Temperature

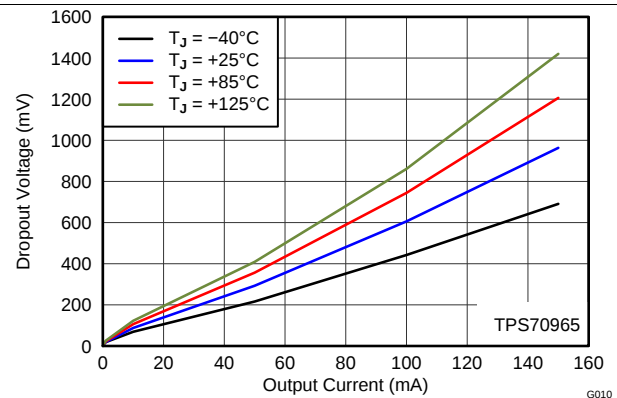


Figure 10. Dropout Voltage vs  $I_{OUT}$  and Temperature

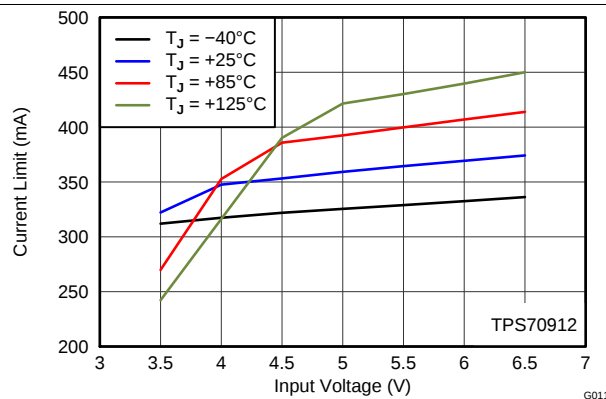


Figure 11. 1.2-V Current Limit vs  $V_{IN}$  and Temperature

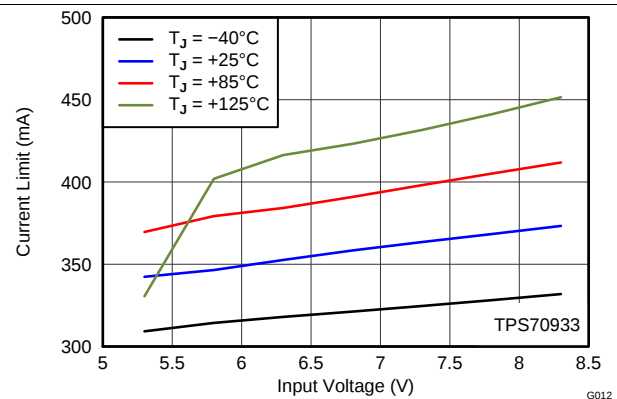


Figure 12. 3.3-V Current Limit vs  $V_{IN}$  and Temperature

## Typical Characteristics (continued)

Over operating temperature range ( $T_J = -40^\circ\text{C}$  to  $125^\circ\text{C}$ ),  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = 2\text{ V}$ ,  $C_{OUT} = 2.2\text{ }\mu\text{F}$ , and  $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$  or  $2.7\text{ V}$  (whichever is greater), unless otherwise noted. Typical values are at  $T_J = 25^\circ\text{C}$ .

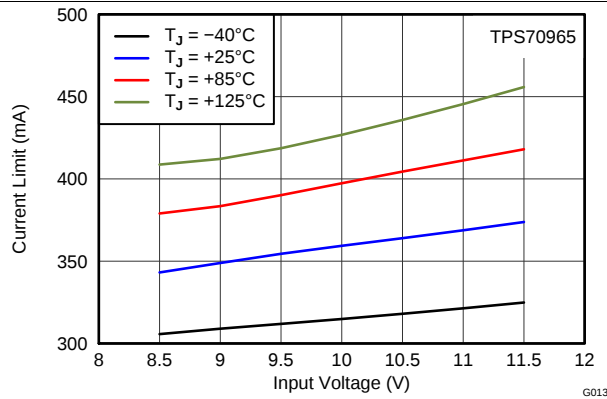


Figure 13. 6.5-V Current Limit vs  $V_{IN}$  and Temperature

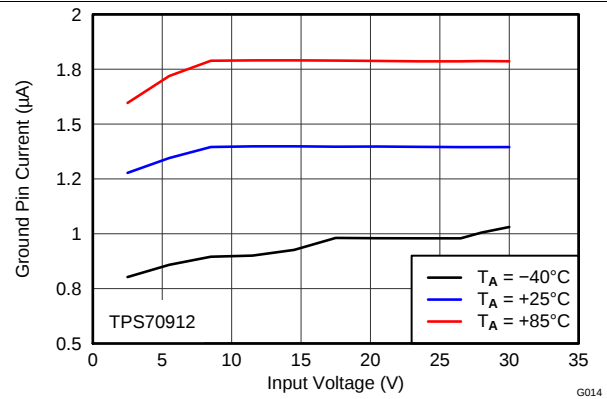


Figure 14. GND Current vs  $V_{IN}$  and Temperature

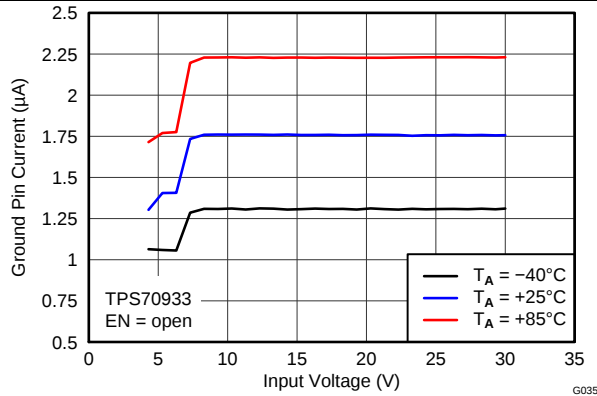


Figure 15. GND Current vs  $V_{IN}$  and Temperature

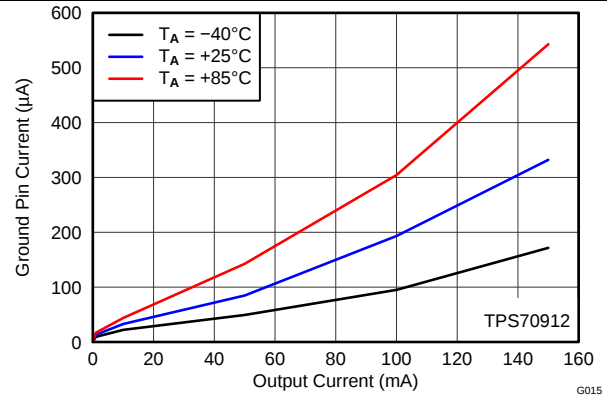


Figure 16. GND Current vs  $I_{OUT}$  and Temperature

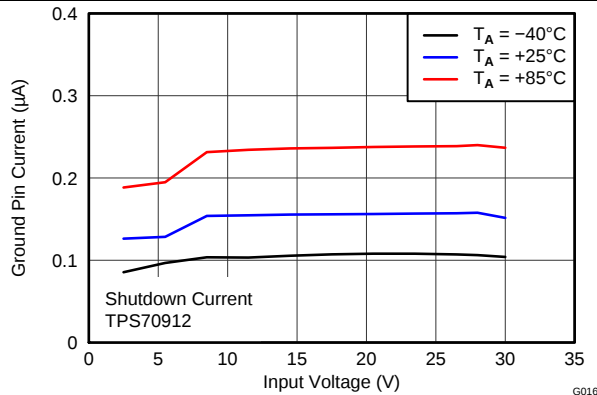


Figure 17. Shutdown Current vs  $V_{IN}$  and Temperature

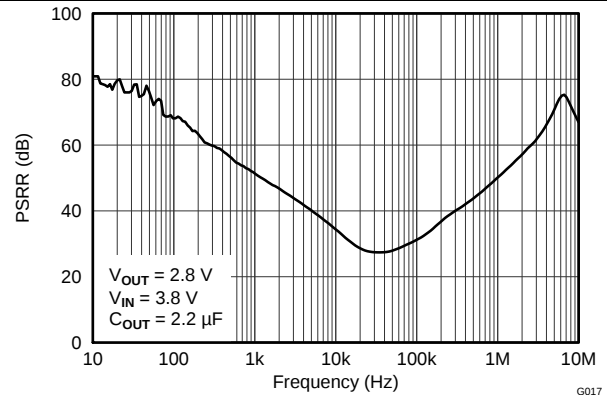
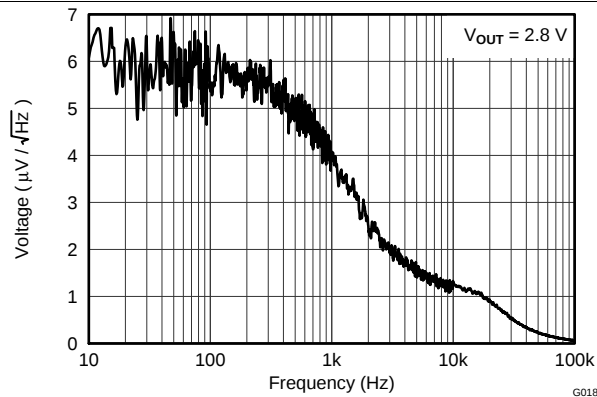
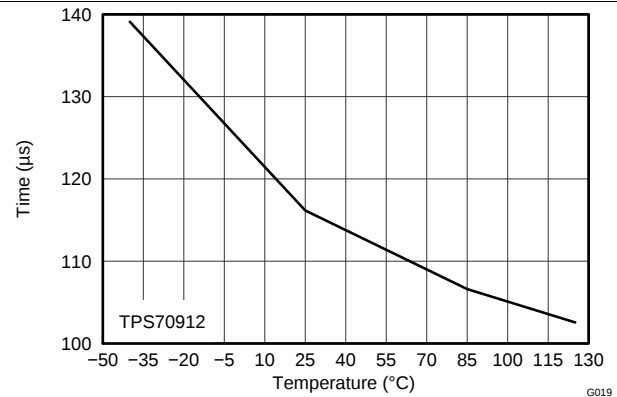
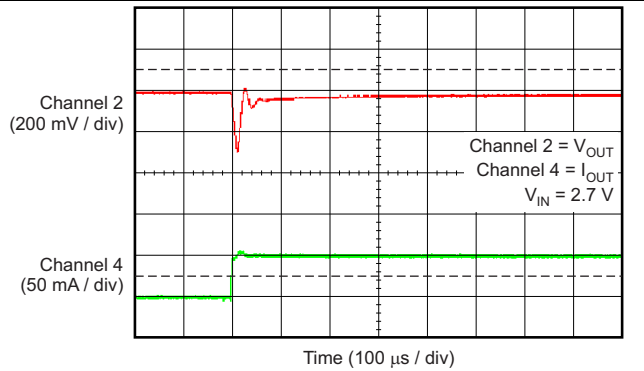
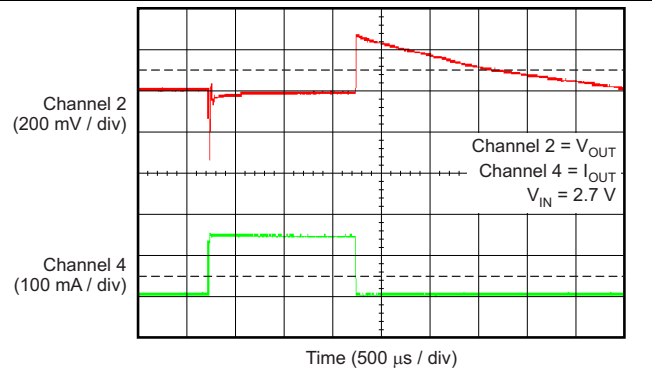
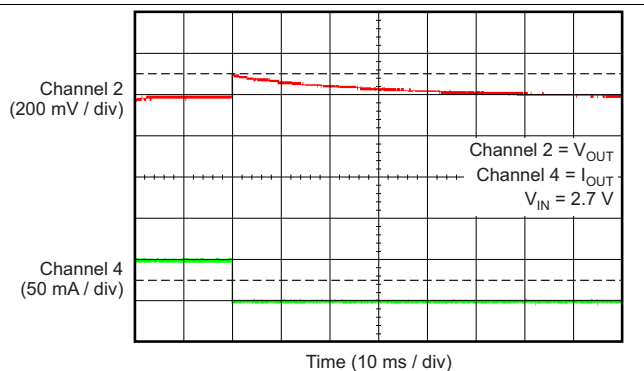
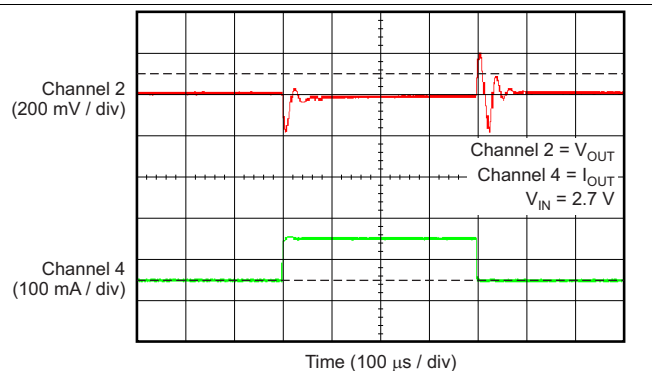


Figure 18. Power-Supply Rejection Ratio vs Frequency

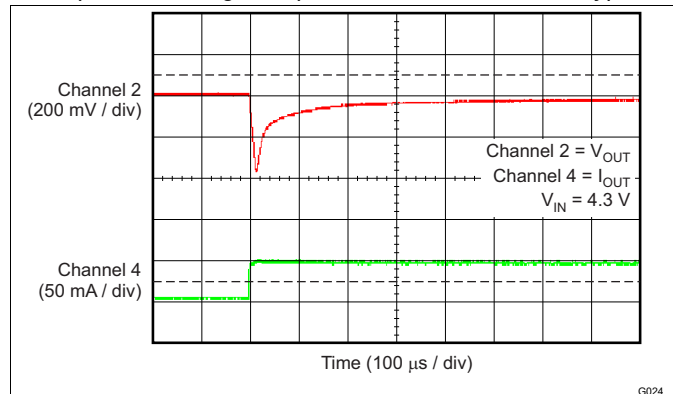
## Typical Characteristics (continued)

Over operating temperature range ( $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ),  $I_{\text{OUT}} = 10\text{ mA}$ ,  $V_{\text{EN}} = 2\text{ V}$ ,  $C_{\text{OUT}} = 2.2\text{ }\mu\text{F}$ , and  $V_{\text{IN}} = V_{\text{OUT(typ)}} + 1\text{ V}$  or  $2.7\text{ V}$  (whichever is greater), unless otherwise noted. Typical values are at  $T_J = 25^{\circ}\text{C}$ .

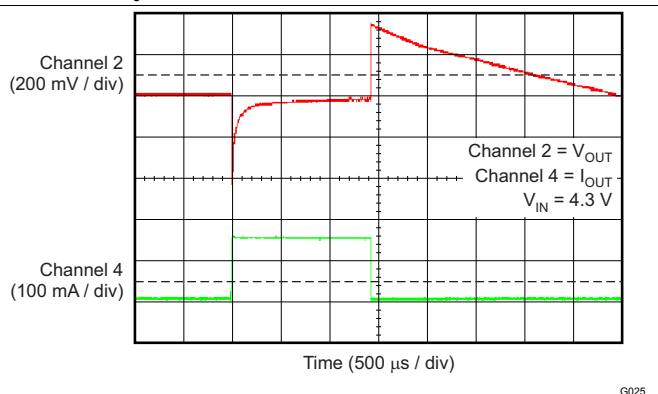

**Figure 19. Noise**

**Figure 20. Start-Up Time vs Temperature**

**Figure 21. TPS70912 Load Transient (0 mA to 50 mA)**

**Figure 22. TPS70912 Load Transient (1 mA to 150 mA)**

**Figure 23. TPS70912 Load Transient (50 mA to 0 mA)**

**Figure 24. TPS70912 Load Transient (50 mA to 150 mA)**

## Typical Characteristics (continued)

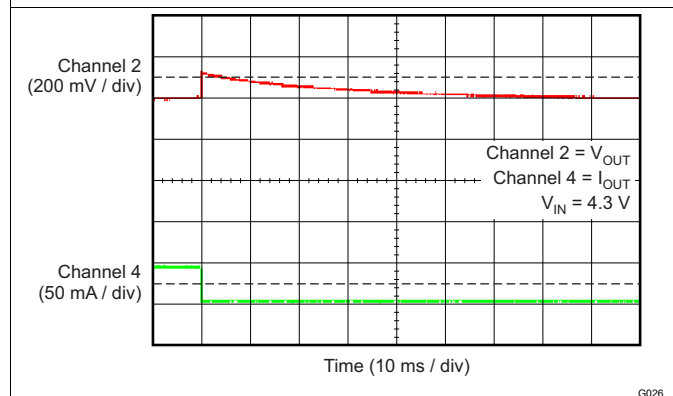
Over operating temperature range ( $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ),  $I_{\text{OUT}} = 10\text{ mA}$ ,  $V_{\text{EN}} = 2\text{ V}$ ,  $C_{\text{OUT}} = 2.2\text{ }\mu\text{F}$ , and  $V_{\text{IN}} = V_{\text{OUT(typ)}} + 1\text{ V}$  or  $2.7\text{ V}$  (whichever is greater), unless otherwise noted. Typical values are at  $T_J = 25^{\circ}\text{C}$ .



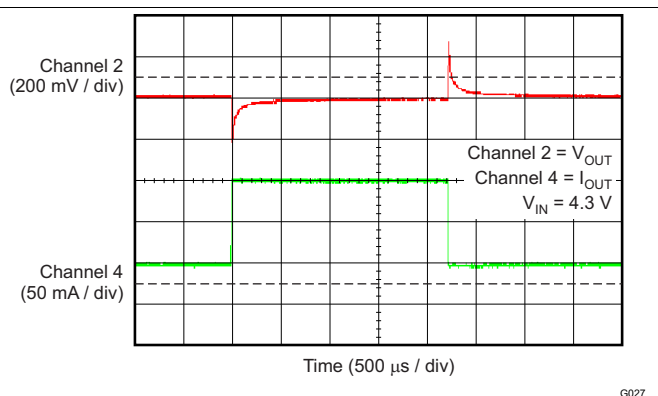
**Figure 25. TPS70933 Load Transient (0 mA to 50 mA)**



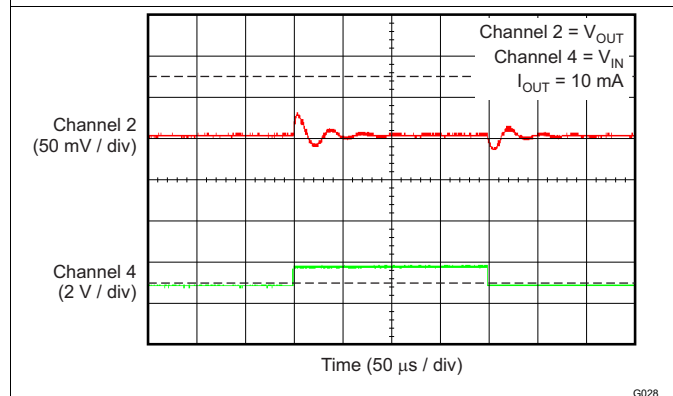
**Figure 26. TPS70933 Load Transient (1 mA to 150 mA)**



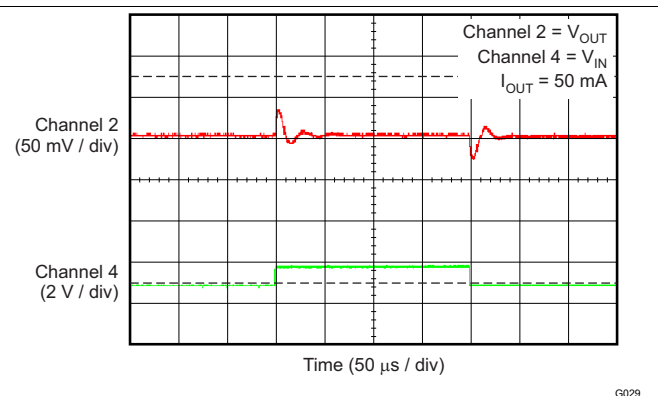
**Figure 27. TPS70933 Load Transient (50 mA to 0 mA)**



**Figure 28. TPS70933 Load Transient (50 mA to 150 mA)**



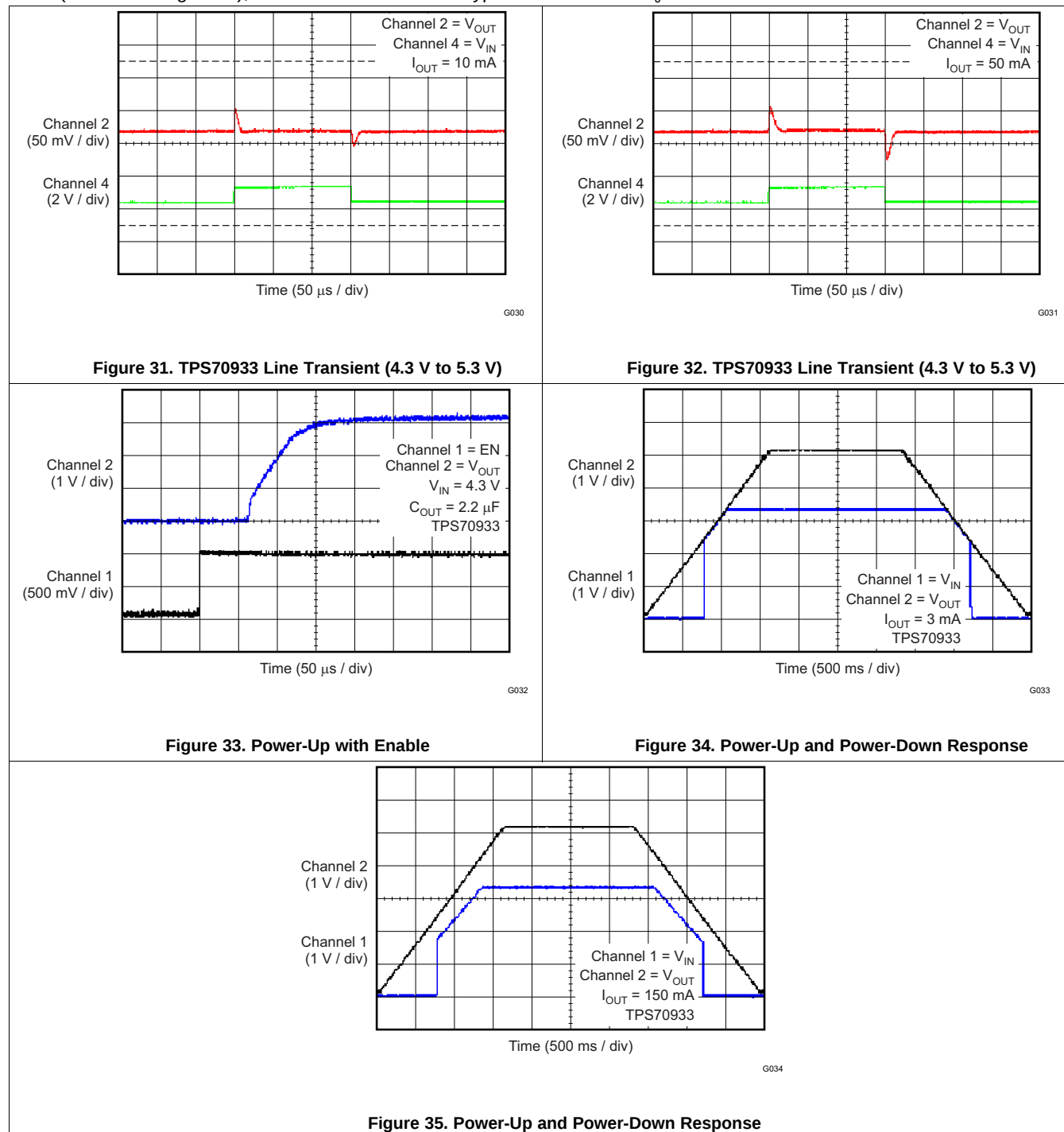
**Figure 29. TPS70912 Line Transient (2.7 V to 3.7 V)**



**Figure 30. TPS70912 Line Transient (2.7 V to 3.7 V)**

## Typical Characteristics (continued)

Over operating temperature range ( $T_J = -40^{\circ}\text{C}$  to  $125^{\circ}\text{C}$ ),  $I_{OUT} = 10\text{ mA}$ ,  $V_{EN} = 2\text{ V}$ ,  $C_{OUT} = 2.2\text{ }\mu\text{F}$ , and  $V_{IN} = V_{OUT(\text{typ})} + 1\text{ V}$  or  $2.7\text{ V}$  (whichever is greater), unless otherwise noted. Typical values are at  $T_J = 25^{\circ}\text{C}$ .

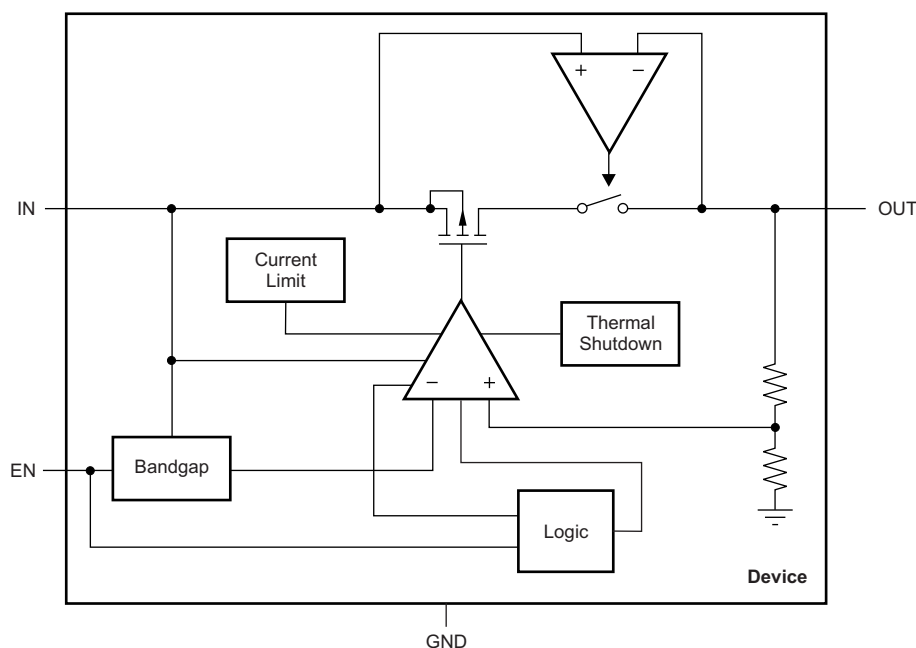


## 7 Detailed Description

### 7.1 Overview

The TPS709 series of devices are ultralow quiescent current, low-dropout (LDO) linear regulators. The TPS709 offers reverse current protection to block any discharge current from the output into the input. The TPS709 also features current limit and thermal shutdown for reliable operation.

### 7.2 Functional Block Diagram



### 7.3 Feature Description

#### 7.3.1 Internal Current Limit

The TPS709 internal current limit helps protect the regulator during fault conditions. During current limit, the output sources a fixed amount of current that is largely independent of output voltage. In such a case, the output voltage is not regulated, and can be measured as  $(V_{OUT} = I_{LIMIT} \times R_{LOAD})$ . The PMOS pass transistor dissipates  $[(V_{IN} - V_{OUT}) \times I_{LIMIT}]$  until a thermal shutdown is triggered and the device turns off. When cool, the device is turned on by the internal thermal shutdown circuit. If the fault condition continues, the device cycles between current limit and thermal shutdown; see the [Thermal Protection](#) section for more details.

The TPS709 is characterized over the recommended operating output current range up to 150 mA. The internal current limit begins to limit the output current at a minimum of 200 mA of output current. The TPS709 continues to operate for output currents between 150 mA and 200 mA but some data sheet parameters may not be met.

#### 7.3.2 Dropout Voltage

The TPS709 use a PMOS pass transistor to achieve low dropout voltage. When  $(V_{IN} - V_{OUT})$  is less than the dropout voltage ( $V_{DO}$ ), the PMOS pass device is in the linear region of operation and the input-to-output resistance is the  $R_{DS(ON)}$  of the PMOS pass element.  $V_{DO}$  approximately scales with the output current because the PMOS device functions like a resistor in dropout.

The ground pin current of many linear voltage regulators increases substantially when the device is operated in dropout. This increase in ground pin current while operating in dropout can be several orders of magnitude larger than when the device is not in dropout. The TPS709 employs a special control loop that limits the increase in ground pin current while operating in dropout. This functionality allows for the most efficient operation while in dropout conditions that can greatly increase battery run times.

## Feature Description (continued)

### 7.3.3 Undervoltage Lockout (UVLO)

The TPS709 uses an undervoltage lockout (UVLO) circuit to keep the output shut off until the internal circuitry operates properly.

### 7.3.4 Reverse-Current Protection

The TPS709 has integrated reverse-current protection. Reverse-current protection prevents the flow of current from the OUT pin to the IN pin when output voltage is higher than input voltage. The reverse-current protection circuitry places the power path in high impedance when the output voltage is higher than the input voltage. This setting reduces leakage current from the output to the input to 10 nA, typical. The reverse current protection is always active regardless of the enable pin logic state or if the OUT pin voltage is greater than 1.8 V. Reverse current can flow if the output voltage is less than 1.8 V and if input voltage is less than the output voltage.

If voltage is applied to the input pin, then the maximum voltage that can be applied to the OUT pin is the lower of three times the nominal output voltage or 6.5 V. For example, if the 1.2-V output voltage version is used, then the maximum reverse bias voltage that can be applied to the OUT pin is 3.6 V. If the 5.0-V output voltage version is used, then the maximum reverse bias voltage that can be applied to the OUT pin is 6.5 V.

## 7.4 Device Functional Modes

The TPS709 has the following functional modes:

1. **Enabled:** When the enable pin (EN) goes above 0.9 V, the device is enabled. EN is pulled high by a 300-nA current source; therefore, EN can be left floating to enable the device. Do not connect EN to VIN. The EN pin is clamped by a 6.5-V Zener diode. Do not exceed the 7-V absolute maximum rating on the enable pin or excessive current flowing into the Zener clamp will destroy the device.
2. **Disabled:** When EN goes below 0.4 V, the device is disabled. During this time, OUT is high impedance and the current into IN ( $I_{\text{SHUTDOWN}}$ ) is typically 150 nA.

## 8 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

The TPS709 is a series of devices that belong to a new family of next-generation voltage regulators. These devices consume low quiescent current and deliver excellent line and load transient performance. This performance, combined with low noise and very good PSRR with little ( $V_{IN} - V_{OUT}$ ) headroom, makes these devices ideal for RF portable applications, current limit, and thermal protection. The TPS709 is specified from  $-40^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$ .

#### 8.1.1 Input and Output Capacitor

The TPS709 devices are stable with output capacitors with an effective capacitance of  $2.0\ \mu\text{F}$  or greater for output voltages below  $1.5\ \text{V}$ . For output voltages equal or greater than  $1.5\ \text{V}$ , the minimum effective capacitance for stability is  $1.5\ \mu\text{F}$ . The maximum capacitance for stability is  $47\ \mu\text{F}$ . The equivalent series resistance (ESR) of the output capacitor must be between  $0\ \Omega$  and  $0.2\ \Omega$  for stability.

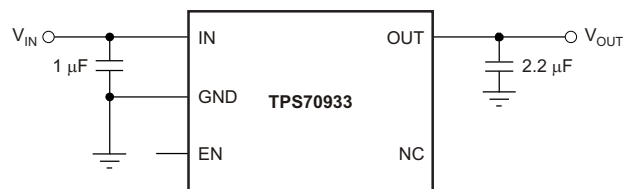
The effective capacitance is the minimum capacitance value of a capacitor after taking into account variations resulting from tolerances, temperature, and dc bias effects. X5R- and X7R-type ceramic capacitors are recommended because these capacitors have minimal variation in value and ESR over temperature.

Although an input capacitor is not required for stability, good analog design practice is to connect a  $0.1\text{-}\mu\text{F}$  to  $2.2\text{-}\mu\text{F}$  capacitor from IN to GND. This capacitor counteracts reactive input sources and improves transient response, input ripple, and PSRR. An input capacitor is necessary if line transients greater than  $10\ \text{V}$  in magnitude are anticipated.

#### 8.1.2 Transient Response

As with any regulator, increasing the output capacitor size reduces over- and undershoot magnitude, but increases transient response duration.

### 8.2 Typical Application



**Figure 36. Wide Input, 3.3-V, Low- $I_Q$  Rail**

#### 8.2.1 Design Requirements

Table 1 summarizes the design requirements for Figure 36.

**Table 1. Design Requirements for a Wide Input, 3.3-V, Low- $I_Q$  Rail Application**

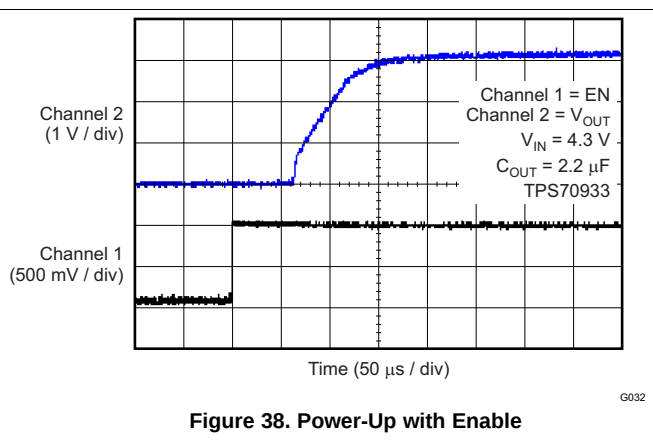
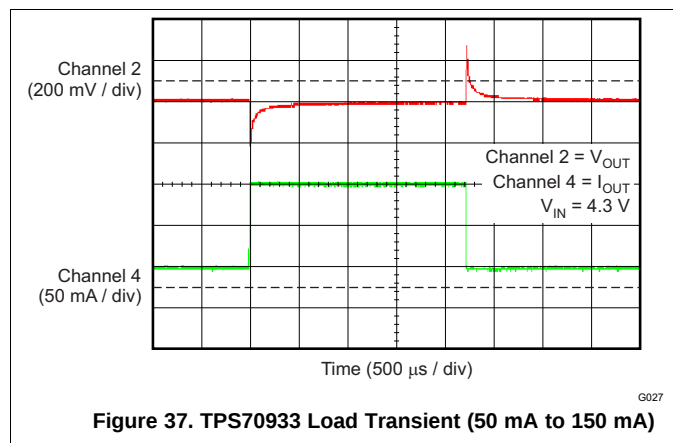
| PARAMETER            | DESIGN SPECIFICATION |
|----------------------|----------------------|
| $V_{IN}$             | 5 V to 20 V          |
| $V_{OUT}$            | 3.3 V                |
| $I_{(IN)}$ (no load) | $< 5\ \mu\text{A}$   |
| $I_{OUT}$ (max)      | 150 mA               |

## 8.2.2 Detailed Design Procedure

Select a 2.2-μF, 10-V X7R output capacitor to satisfy the minimum output capacitance requirement with a 3.3-V dc bias.

Select a 1.0-μF, 25-V X7R input capacitor to provide input noise filtering and eliminate high-frequency voltage transients.

## 8.2.3 Application Curves



# 9 Power Supply Recommendations

This device is designed to operate with an input supply range of 2.7 V to 30 V. If the input supply is noisy, additional input capacitors with low ESR can help improve output noise performance.

## 9.1 Power Dissipation

The ability to remove heat from the die is different for each package type, presenting different considerations in the printed circuit board (PCB) layout. The PCB area around the device that is free of other components moves the heat from the device to ambient air. Performance data for JEDEC low and high-K boards are given in the [Thermal Information](#) table. Using heavier copper increases the effectiveness in removing heat from the device. The addition of plated through-holes to heat-dissipating layers also improves the heatsink effectiveness.

Power dissipation depends on input voltage and load conditions. Power dissipation ( $P_{DISS}$ ) is equal to the product of the output current and the voltage drop across the output pass element, as shown in [Equation 1](#):

$$P_{DISS} = (V_{IN} - V_{OUT}) \times I_{OUT} \quad (1)$$

## 10 Layout

### 10.1 Layout Guidelines

Place input and output capacitors as close to the device pins as possible. To improve ac performance (such as PSRR, output noise, and transient response), TI recommends that the board be designed with separate ground planes for  $V_{IN}$  and  $V_{OUT}$ , with the ground plane connected only at the GND pin of the device. In addition, the ground connection for the output capacitor must be connected directly to the device GND pin.

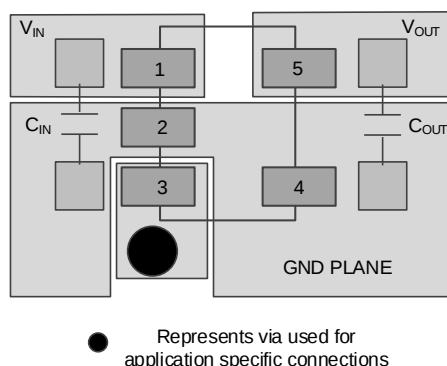
#### 10.1.1 Thermal Protection

Thermal protection disables the output when the junction temperature rises to approximately 165°C, allowing the device to cool. When the junction temperature cools to approximately 145°C, the output circuitry is again enabled. Depending on power dissipation, thermal resistance, and ambient temperature, the thermal protection circuit can cycle on and off. This cycling limits the dissipation of the regulator, protecting it from damage as a result of overheating.

Any tendency to activate the thermal protection circuit indicates excessive power dissipation or an inadequate heatsink. For reliable operation, limit junction temperature to 125°C, maximum. To estimate the margin of safety in a complete design (including heatsink), increase the ambient temperature until the thermal protection is triggered; use worst-case loads and signal conditions. For good reliability, thermal protection must trigger at least 35°C above the maximum expected ambient condition of the particular application. This configuration produces a worst-case junction temperature of 125°C at the highest expected ambient temperature and worst-case load.

The TPS709 internal protection circuitry is designed to protect against overload conditions. This circuitry is not intended to replace proper heatsinking. Continuously running the TPS709 into thermal shutdown degrades device reliability.

### 10.2 Layout Example



**Figure 39. Layout Example for DBV Package**

## 11 Device and Documentation Support

### 11.1 Device Support

#### 11.1.1 Development Support

##### 11.1.1.1 Evaluation Modules

An evaluation module (EVM) is available to assist in the initial circuit performance evaluation using the TPS709xx. The [TPS70933EVM-110 evaluation module](#) (and [related user guide](#)) can be requested at the Texas Instruments website through the product folders or purchased directly from the [TI eStore](#).

##### 11.1.1.2 Spice Models

Computer simulation of circuit performance using SPICE is often useful when analyzing the performance of analog circuits and systems. A SPICE model for the TPS709 is available through the product folders under *Simulation Models*.

#### 11.1.2 Device Nomenclature

**Table 2. Device Nomenclature<sup>(1)</sup>**

| PRODUCT         | V <sub>OUT</sub>                                                                                                                                                                                                                                                                                                                          |
|-----------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| TPS709xx(x)yyyz | <p><b>XX(X)</b> is the nominal output voltage. For output voltages with a resolution of 100 mV, two digits are used in the ordering number; otherwise, three digits are used (for example, 28 = 2.8 V; 125 = 1.25 V).</p> <p><b>YYY</b> is the package designator.</p> <p><b>Z</b> is the tape and reel quantity (R = 3000, T = 250).</p> |

(1) For the most current package and ordering information see the Package Option Addendum at the end of this document, or see the TI web site at [www.ti.com](#).

### 11.2 Documentation Support

#### 11.2.1 Related Documentation

- TPS70933EVM-110 Evaluation Module User Guide, [SLVU689](#)

### 11.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](#), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

## 11.4 Trademarks

E2E is a trademark of Texas Instruments.

Zigbee is a trademark of ZigBee Alliance.

All other trademarks are the property of their respective owners.

## 11.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 11.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS70912DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCX                     | <a href="#">Samples</a> |
| TPS70912DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCX                     | <a href="#">Samples</a> |
| TPS70912DRVR     | ACTIVE        | SON          | DRV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCX                     | <a href="#">Samples</a> |
| TPS70912DRVVT    | ACTIVE        | SON          | DRV                | 6    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCX                     | <a href="#">Samples</a> |
| TPS709135DBVR    | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCY                     | <a href="#">Samples</a> |
| TPS709135DBVT    | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCY                     | <a href="#">Samples</a> |
| TPS70915DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIM                     | <a href="#">Samples</a> |
| TPS70915DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIM                     | <a href="#">Samples</a> |
| TPS70915DRVR     | ACTIVE        | SON          | DRV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIM                     | <a href="#">Samples</a> |
| TPS70915DRVVT    | ACTIVE        | SON          | DRV                | 6    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIM                     | <a href="#">Samples</a> |
| TPS70916DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCZ                     | <a href="#">Samples</a> |
| TPS70916DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SCZ                     | <a href="#">Samples</a> |
| TPS70918DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDA                     | <a href="#">Samples</a> |
| TPS70918DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDA                     | <a href="#">Samples</a> |
| TPS70918DRVR     | ACTIVE        | SON          | DRV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDA                     | <a href="#">Samples</a> |
| TPS70918DRVVT    | ACTIVE        | SON          | DRV                | 6    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDA                     | <a href="#">Samples</a> |
| TPS70919DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDB                     | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS70919DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDB                     | <a href="#">Samples</a> |
| TPS70925DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDC                     | <a href="#">Samples</a> |
| TPS70925DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDC                     | <a href="#">Samples</a> |
| TPS70925DRVR     | ACTIVE        | SON          | DRV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDC                     | <a href="#">Samples</a> |
| TPS70925DRVVT    | ACTIVE        | SON          | DRV                | 6    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDC                     | <a href="#">Samples</a> |
| TPS70927DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDD                     | <a href="#">Samples</a> |
| TPS70927DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDD                     | <a href="#">Samples</a> |
| TPS70928DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDE                     | <a href="#">Samples</a> |
| TPS70928DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDE                     | <a href="#">Samples</a> |
| TPS70930DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDF                     | <a href="#">Samples</a> |
| TPS70930DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDF                     | <a href="#">Samples</a> |
| TPS70930DRVR     | ACTIVE        | SON          | DRV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDF                     | <a href="#">Samples</a> |
| TPS70930DRVVT    | ACTIVE        | SON          | DRV                | 6    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDF                     | <a href="#">Samples</a> |
| TPS70933DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDG                     | <a href="#">Samples</a> |
| TPS70933DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDG                     | <a href="#">Samples</a> |
| TPS70933DRVR     | ACTIVE        | SON          | DRV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDG                     | <a href="#">Samples</a> |
| TPS70933DRVVT    | ACTIVE        | SON          | DRV                | 6    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDG                     | <a href="#">Samples</a> |
| TPS70936DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SEJ                     | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS70936DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SEJ                     | <a href="#">Samples</a> |
| TPS70938DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIC                     | <a href="#">Samples</a> |
| TPS70938DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIC                     | <a href="#">Samples</a> |
| TPS70939DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SID                     | <a href="#">Samples</a> |
| TPS70939DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SID                     | <a href="#">Samples</a> |
| TPS70950DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDH                     | <a href="#">Samples</a> |
| TPS70950DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDH                     | <a href="#">Samples</a> |
| TPS70950DRVVR    | ACTIVE        | SON          | DRV                | 6    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDH                     | <a href="#">Samples</a> |
| TPS70950DRVVT    | ACTIVE        | SON          | DRV                | 6    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SDH                     | <a href="#">Samples</a> |
| TPS70960DBVR     | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIT                     | <a href="#">Samples</a> |
| TPS70960DBVT     | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | SIT                     | <a href="#">Samples</a> |
| TPS709A30DBVR    | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 11RF                    | <a href="#">Samples</a> |
| TPS709A30DBVT    | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 11RF                    | <a href="#">Samples</a> |
| TPS709A33DBVR    | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 11SF                    | <a href="#">Samples</a> |
| TPS709A33DBVT    | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 11SF                    | <a href="#">Samples</a> |
| TPS709B33DBVR    | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 13C7                    | <a href="#">Samples</a> |
| TPS709B33DBVT    | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 13C7                    | <a href="#">Samples</a> |
| TPS709B50DBVR    | ACTIVE        | SOT-23       | DBV                | 5    | 3000           | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 13D7                    | <a href="#">Samples</a> |

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| TPS709B50DBVT    | ACTIVE        | SOT-23       | DBV                | 5    | 250            | Green (RoHS<br>& no Sb/Br) | CU NIPDAU               | Level-1-260C-UNLIM   | -40 to 125   | 13D7                    | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

**TBD:** The Pb-Free/Green conversion plan has not been defined.

**Pb-Free (RoHS):** TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

**Pb-Free (RoHS Exempt):** This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

**Green (RoHS & no Sb/Br):** TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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**OTHER QUALIFIED VERSIONS OF TPS709 :**

- Automotive: [TPS709-Q1](#)

NOTE: Qualified Version Definitions:

- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

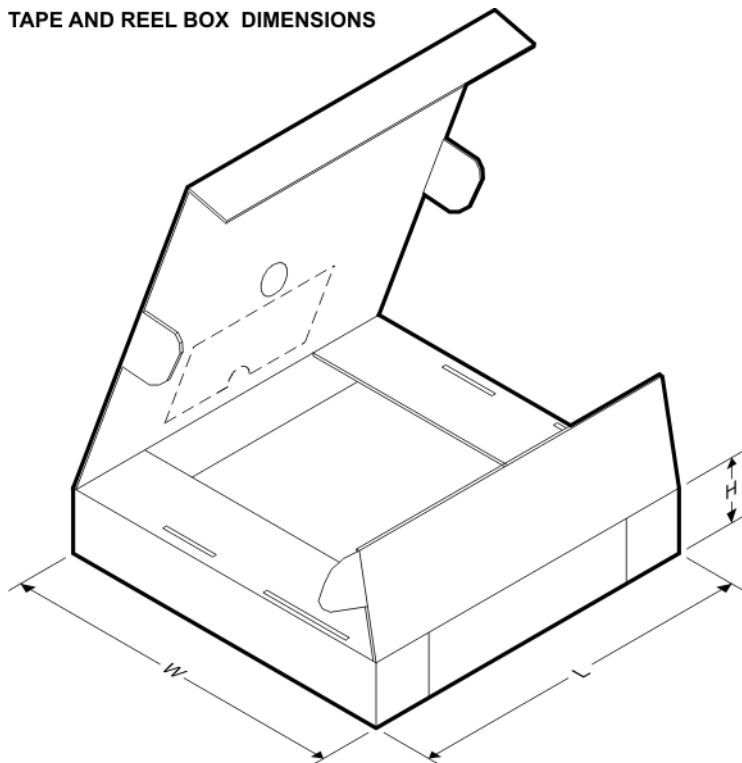
**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS70912DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS70912DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70912DRVR  | SON          | DRV             | 6    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70912DRVT  | SON          | DRV             | 6    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS709135DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709135DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70915DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70915DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70915DRVR  | SON          | DRV             | 6    | 3000 | 179.0              | 8.4                | 2.2     | 2.2     | 1.2     | 4.0     | 8.0    | Q2            |
| TPS70915DRVR  | SON          | DRV             | 6    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70915DRVT  | SON          | DRV             | 6    | 250  | 179.0              | 8.4                | 2.2     | 2.2     | 1.2     | 4.0     | 8.0    | Q2            |
| TPS70915DRVT  | SON          | DRV             | 6    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70916DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70916DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70918DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70918DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70918DRVR  | SON          | DRV             | 6    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70918DRVR  | SON          | DRV             | 6    | 3000 | 179.0              | 8.4                | 2.2     | 2.2     | 1.2     | 4.0     | 8.0    | Q2            |

| Device        | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|---------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| TPS70918DRV   | SON          | DRV             | 6    | 250  | 179.0              | 8.4                | 2.2     | 2.2     | 1.2     | 4.0     | 8.0    | Q2            |
| TPS70918DRV   | SON          | DRV             | 6    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70919DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70919DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70925DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70925DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS70925DRV   | SON          | DRV             | 6    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70925DRV   | SON          | DRV             | 6    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70927DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70927DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70928DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70928DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70930DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70930DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70930DRV   | SON          | DRV             | 6    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70930DRV   | SON          | DRV             | 6    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70933DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS70933DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70933DRV   | SON          | DRV             | 6    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70933DRV   | SON          | DRV             | 6    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70936DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.3     | 3.2     | 1.4     | 4.0     | 8.0    | Q3            |
| TPS70936DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70938DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70938DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70939DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70939DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70950DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70950DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70950DRV   | SON          | DRV             | 6    | 3000 | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70950DRV   | SON          | DRV             | 6    | 3000 | 179.0              | 8.4                | 2.2     | 2.2     | 1.2     | 4.0     | 8.0    | Q2            |
| TPS70950DRV   | SON          | DRV             | 6    | 250  | 179.0              | 8.4                | 2.2     | 2.2     | 1.2     | 4.0     | 8.0    | Q2            |
| TPS70950DRV   | SON          | DRV             | 6    | 250  | 180.0              | 8.4                | 2.3     | 2.3     | 1.15    | 4.0     | 8.0    | Q2            |
| TPS70960DBVR  | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS70960DBVT  | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709A30DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709A30DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709A33DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709A33DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709B33DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709B33DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709B50DBVR | SOT-23       | DBV             | 5    | 3000 | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |
| TPS709B50DBVT | SOT-23       | DBV             | 5    | 250  | 178.0              | 9.0                | 3.23    | 3.17    | 1.37    | 4.0     | 8.0    | Q3            |

## TAPE AND REEL BOX DIMENSIONS



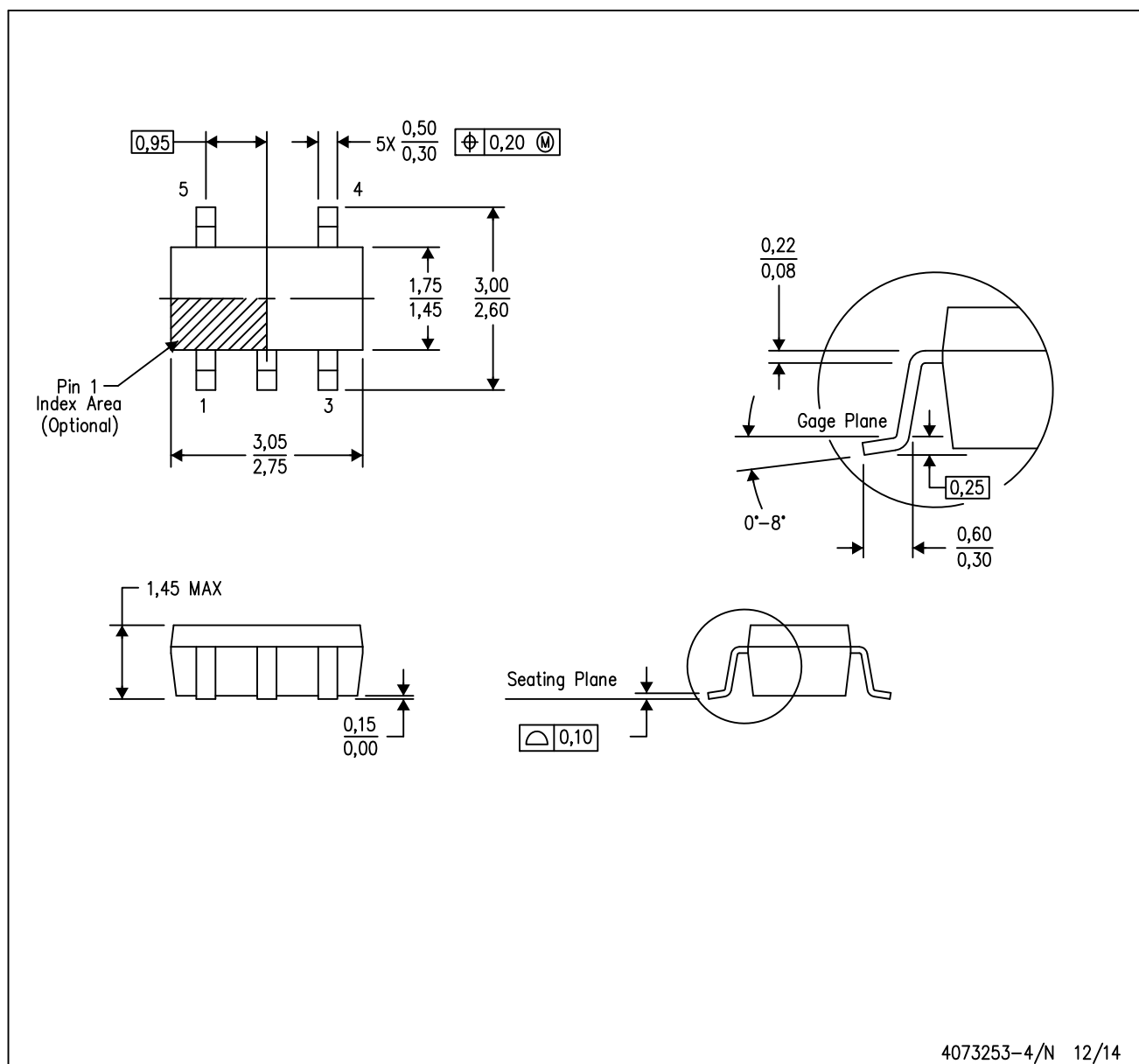
\*All dimensions are nominal

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS70912DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70912DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70912DRVR  | SON          | DRV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS70912DRVT  | SON          | DRV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS709135DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS709135DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70915DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70915DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70915DRVR  | SON          | DRV             | 6    | 3000 | 203.0       | 203.0      | 35.0        |
| TPS70915DRVR  | SON          | DRV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS70915DRVT  | SON          | DRV             | 6    | 250  | 203.0       | 203.0      | 35.0        |
| TPS70915DRVT  | SON          | DRV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS70916DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70916DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70918DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70918DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70918DRVR  | SON          | DRV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS70918DRVR  | SON          | DRV             | 6    | 3000 | 203.0       | 203.0      | 35.0        |
| TPS70918DRVT  | SON          | DRV             | 6    | 250  | 203.0       | 203.0      | 35.0        |
| TPS70918DRVT  | SON          | DRV             | 6    | 250  | 210.0       | 185.0      | 35.0        |

| Device        | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| TPS70919DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70919DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70925DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70925DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70925DRVVR | SON          | DRV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS70925DRVVT | SON          | DRV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS70927DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70927DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70928DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70928DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70930DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70930DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70930DRVVR | SON          | DRV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS70930DRVVT | SON          | DRV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS70933DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70933DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70933DRVVR | SON          | DRV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS70933DRVVT | SON          | DRV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS70936DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70936DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70938DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70938DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70939DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70939DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70950DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70950DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS70950DRVVR | SON          | DRV             | 6    | 3000 | 210.0       | 185.0      | 35.0        |
| TPS70950DRVVR | SON          | DRV             | 6    | 3000 | 203.0       | 203.0      | 35.0        |
| TPS70950DRVVT | SON          | DRV             | 6    | 250  | 203.0       | 203.0      | 35.0        |
| TPS70950DRVVT | SON          | DRV             | 6    | 250  | 210.0       | 185.0      | 35.0        |
| TPS70960DBVR  | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS70960DBVT  | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS709A30DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS709A30DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS709A33DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS709A33DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS709B33DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS709B33DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |
| TPS709B50DBVR | SOT-23       | DBV             | 5    | 3000 | 180.0       | 180.0      | 18.0        |
| TPS709B50DBVT | SOT-23       | DBV             | 5    | 250  | 180.0       | 180.0      | 18.0        |

DBV (R-PDSO-G5)

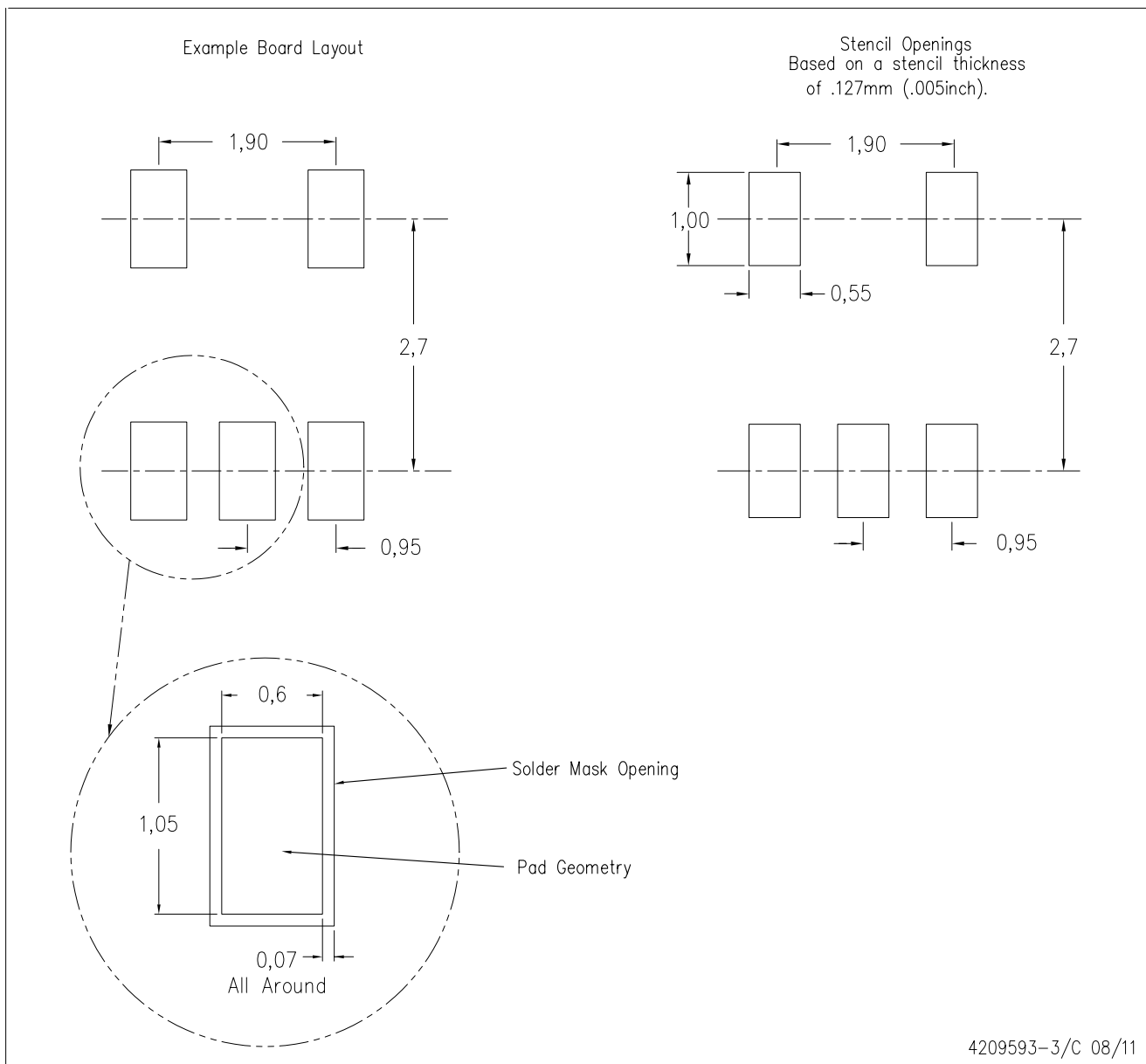
PLASTIC SMALL-OUTLINE PACKAGE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Body dimensions do not include mold flash or protrusion. Mold flash and protrusion shall not exceed 0.15 per side.
  - D. Falls within JEDEC MO-178 Variation AA.

DBV (R-PDSO-G5)

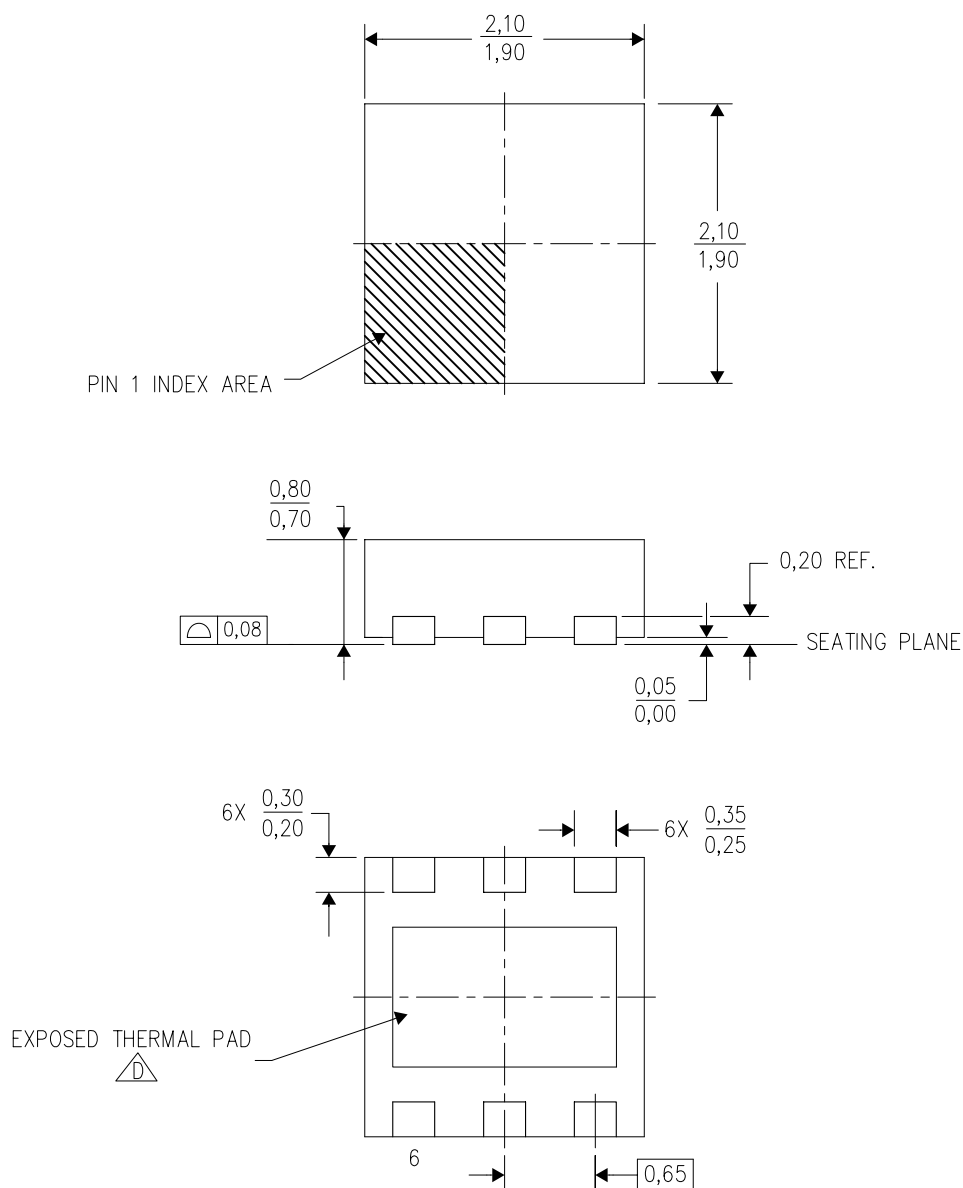
PLASTIC SMALL OUTLINE



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Customers should place a note on the circuit board fabrication drawing not to alter the center solder mask defined pad.
  - D. Publication IPC-7351 is recommended for alternate designs.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Example stencil design based on a 50% volumetric metal load solder paste. Refer to IPC-7525 for other stencil recommendations.

DRV (S-PWSON-N6)

PLASTIC SMALL OUTLINE NO-LEAD



4206925/E 10/10

- NOTES:
- A. All linear dimensions are in millimeters. Dimensioning and tolerancing per ASME Y14.5M-1994.
  - B. This drawing is subject to change without notice.
  - C. Small Outline No-Lead (SON) package configuration.
  -  D. The package thermal pad must be soldered to the board for thermal and mechanical performance. See the Product Data Sheet for details regarding the exposed thermal pad dimensions.

## THERMAL PAD MECHANICAL DATA

DRV (S-PWSON-N6)

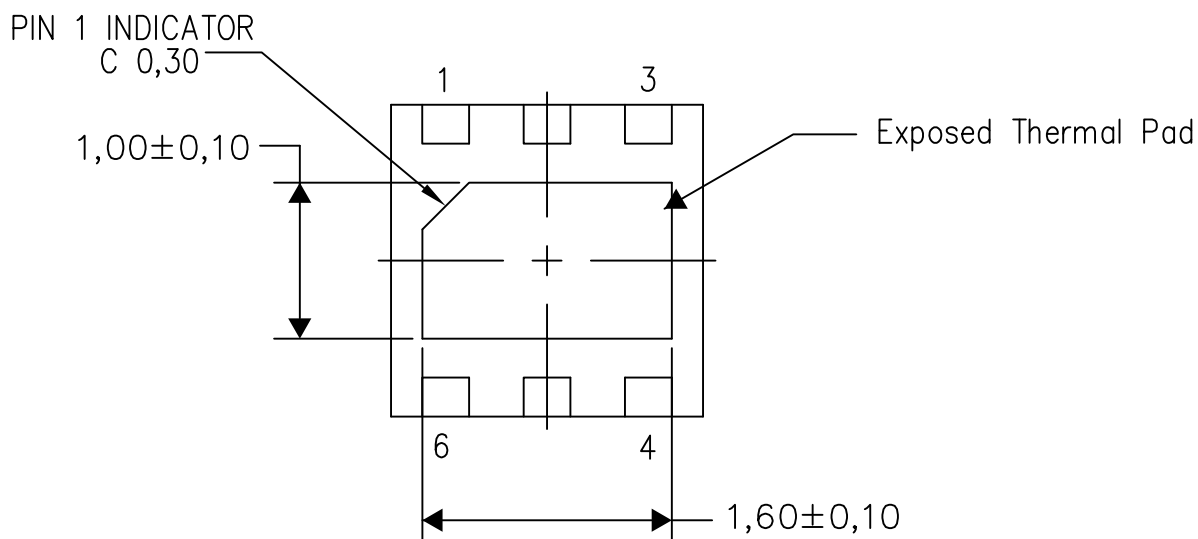
PLASTIC SMALL OUTLINE NO-LEAD

### THERMAL INFORMATION

This package incorporates an exposed thermal pad that is designed to be attached directly to an external heatsink. The thermal pad must be soldered directly to the printed circuit board (PCB). After soldering, the PCB can be used as a heatsink. In addition, through the use of thermal vias, the thermal pad can be attached directly to the appropriate copper plane shown in the electrical schematic for the device, or alternatively, can be attached to a special heatsink structure designed into the PCB. This design optimizes the heat transfer from the integrated circuit (IC).

For information on the Quad Flatpack No-Lead (QFN) package and its advantages, refer to Application Report, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271. This document is available at [www.ti.com](http://www.ti.com).

The exposed thermal pad dimensions for this package are shown in the following illustration.



Bottom View

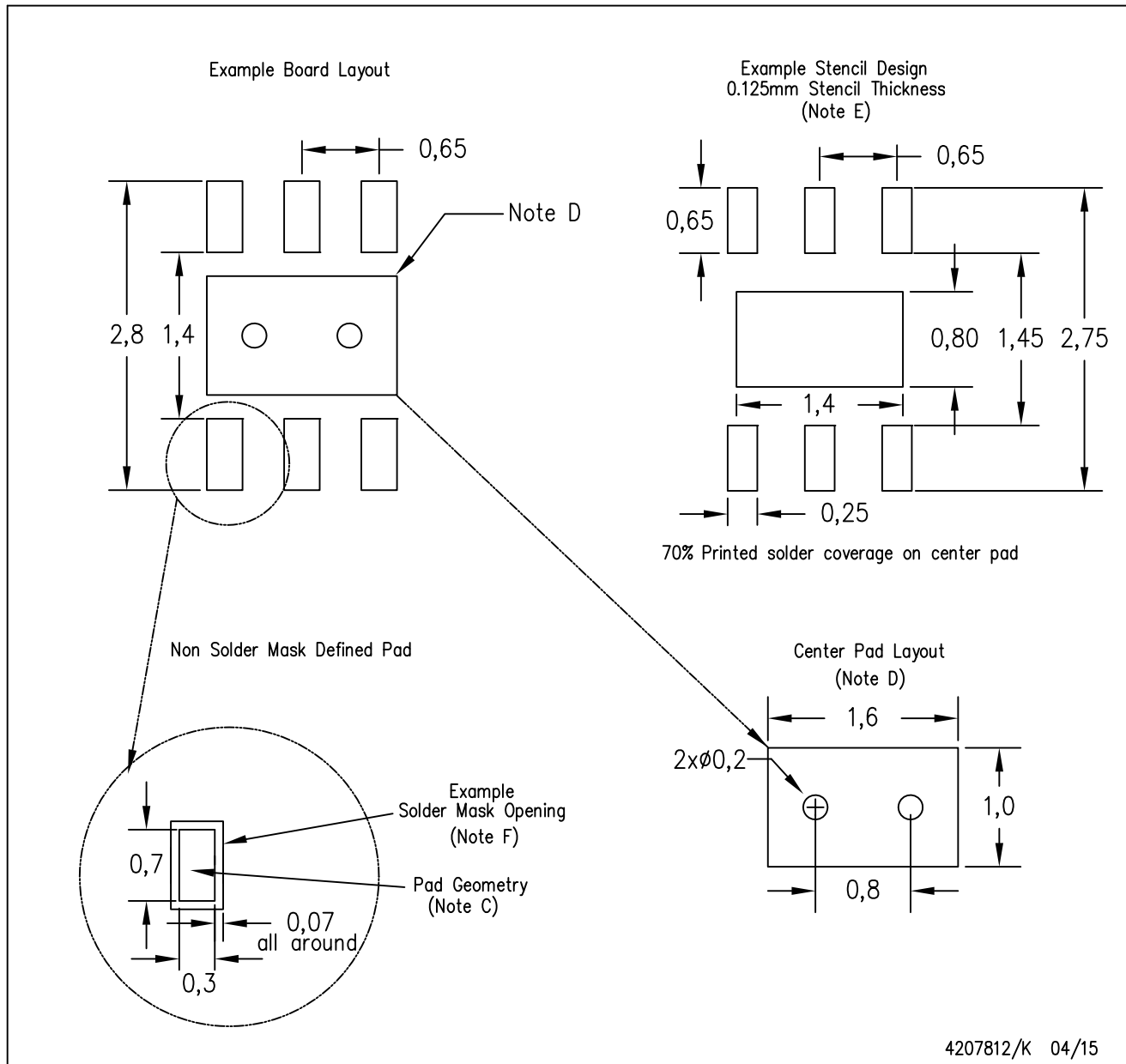
Exposed Thermal Pad Dimensions

4206926/Q 04/15

NOTE: All linear dimensions are in millimeters

DRV (S-PWSON-N6)

PLASTIC SMALL OUTLINE NO-LEAD



- NOTES:
- A. All linear dimensions are in millimeters.
  - B. This drawing is subject to change without notice.
  - C. Publication IPC-7351 is recommended for alternate designs.
  - D. This package is designed to be soldered to a thermal pad on the board. Refer to Application Note, QFN/SON PCB Attachment, Texas Instruments Literature No. SLUA271, and also the Product Data Sheets for specific thermal information, via requirements, and recommended board layout. These documents are available at [www.ti.com](http://www.ti.com) <<http://www.ti.com>>.
  - E. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC 7525 for stencil design considerations.
  - F. Customers should contact their board fabrication site for solder mask tolerances.

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|                               |                                                                                          |
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